

TECHNICAL SPECIFICATIONS

T_A = 25°C, airflow rate = 300 LFM, V_{in} = 8.3Vdc and 14Vdc, nominal V_{out} unless otherwise noted.

PARAMETER	NOTES and CONDITIONS	DNM10S0A0R10NFD			
		Min.	Typ.	Max.	Units
ABSOLUTE MAXIMUM RATINGS					
Input Voltage (Continuous)		0		15	Vdc
Tracking Voltage		0		V _{in,max}	Vdc
Operating Temperature	Refer to Figure 31 for the measuring point	-40		120	°C
Storage Temperature		-55		125	°C
INPUT CHARACTERISTICS					
Operating Input Voltage	V _{o,set} ≤ 3.63Vdc	8.3	12	14	V
	V _{o,set} > 3.63Vdc	8.3	12	13.2	V
Input Under-Voltage Lockout					
Turn-On Voltage Threshold			7.9		V
Turn-Off Voltage Threshold			7.8		V
Maximum Input Current	V _{in} =V _{in,min} to V _{in,max} , I _o =I _{o,max}			7	A
No-Load Input Current	V _{in} =12V, I _o =Min Load		100		mA
Off Converter Input Current	V _{in} =12V, Off Converter		2		mA
Inrush Transient	V _{in} = V _{in,min} to V _{in,max} , I _o =I _{o,min} to I _{o,max}			0.4	A ² S
Recommended Inout Fuse				15	A
OUTPUT CHARACTERISTICS					
Output Voltage Set Point	V _{in} =12V, I _o =I _{o,max}	-2.0	V _{o,set}	+2.0	% V _{o,set}
Output Voltage Adjustable Range		0.7525		5	V
Output Voltage Regulation					
Over Line	V _{in} =V _{in,min} to V _{in,max}		0.3		% V _{o,set}
Over Load	I _o =I _{o,min} to I _{o,max}		0.4		% V _{o,set}
Over Temperature	T _a = -40°C to 85°C		0.4		% V _{o,set}
Total Output Voltage Range	Over sample load, line and temperature	-2.5		+3.5	% V _{o,set}
Output Voltage Ripple and Noise	5Hz to 20MHz bandwidth				
Peak-to-Peak	V _{in} =min to max, I _o =min to max 1μF ceramic, 10μF Tan		30	75	mV
RMS	V _{in} =min to max, I _o =min to max 1μF ceramic, 10μF Tan		12	30	mV
Output Current Range		0		10	A
Output Voltage Over-shoot at Start-up	V _{out} =3.3V			1	% V _{o,set}
Output DC Current-Limit Inception	V _{out} =90%V _{o,set}		200		% I _o
Output Short-Circuit Current (Hiccup mode)	I _{o,s/c}		3		Adc
DYNAMIC CHARACTERISTICS					
Dynamic Load Response	10μF Tan & 1μF ceramic load cap, 2.5A/μs, V _{in} =12V				
Positive Step Change in Output Current	50% I _o , max to 100% I _o , max		200		mVpk
Negative Step Change in Output Current	100% I _o , max to 50% I _o , max		200		mVpk
Settling Time to 10% of Peak Deviation			25		μs
Turn-On Transient	I _o =I _{o,max}				
Start-Up Time, From On/Off Control	V _{on/off} , V _o =10% of V _{o,set}		5		ms
Start-Up Time, From Input	V _{in} =V _{in,min} , V _o =10% of V _{o,set}		5		ms
Output Voltage Rise Time	Time for V _o to rise from 10% to 90% of V _{o,set}		4	6	ms
Output Capacitive Load	Full load; ESR ≥ 1mΩ			1000	μF
	Full load; ESR ≥ 10mΩ, V _{in} <9.0V			3500	μF
	Full load; ESR ≥ 10mΩ, V _{in} ≥9.0V			5000	μF
EFFICIENCY					
V _o =0.75V	V _{in} =12V, I _o =I _{o,max}		81.0		%
V _o =1.2V	V _{in} =12V, I _o =I _{o,max}		86.5		%
V _o =1.5V	V _{in} =12V, I _o =I _{o,max}		88.5		%
V _o =1.8V	V _{in} =12V, I _o =I _{o,max}		90.0		%
V _o =2.5V	V _{in} =12V, I _o =I _{o,max}		91.5		%
V _o =3.3V	V _{in} =12V, I _o =I _{o,max}		93.0		%
V _o =5.0V	V _{in} =12V, I _o =I _{o,max}		94.5		%
FEATURE CHARACTERISTICS					
Switching Frequency			300		kHz
ON/OFF Control, (Negative logic)					
Logic Low Voltage	Module On, V _{on/off}	-0.2		0.3	V
Logic High Voltage	Module Off, V _{on/off}	2.5		V _{in,max}	V
Logic Low Current	Module On, I _{on/off}			10	μA
Logic High Current	Module Off, I _{on/off}		0.2	1	mA
ON/OFF Control, (Positive Logic)					
Logic High Voltage	Module On, V _{on/off}			V _{in,max}	V
Logic Low Voltage	Module Off, V _{on/off}	-0.2		0.3	V
Logic High Current	Module On, I _{on/off}			10	μA
Logic Low Current	Module Off, I _{on/off}		0.2	1	mA
Tracking Slew Rate Capability		0.1		2	V/msec
Tracking Delay Time	Delay from V _{in,min} to application of tracking voltage	10			ms
Tracking Accuracy	Power-up, subject to 2V/mS		100	200	mV
	Power-down, subject to 1V/mS		200	400	mV
Remote Sense Range				0.1	V
GENERAL SPECIFICATIONS					
MTBF	I _o =I _{o,max} , T _a =25°C		10.13		M hours
Weight			12		grams
Over-Temperature Shutdown	Refer to Figure 32 for the measuring point		125		°C

ELECTRICAL CHARACTERISTICS CURVES

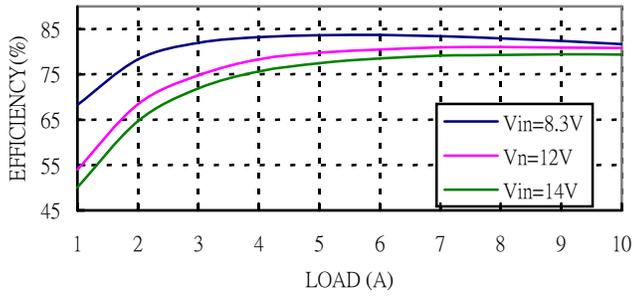


Figure 1: Converter efficiency vs. output current (0.75V output voltage)

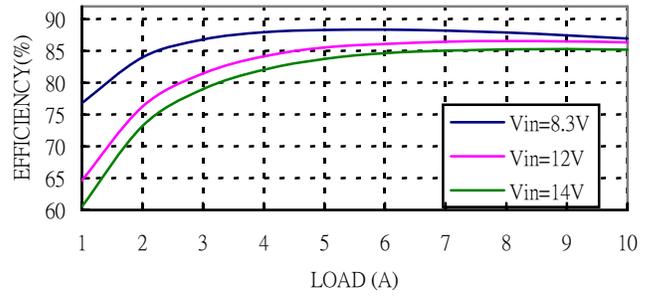


Figure 2: Converter efficiency vs. output current (1.2V output voltage)

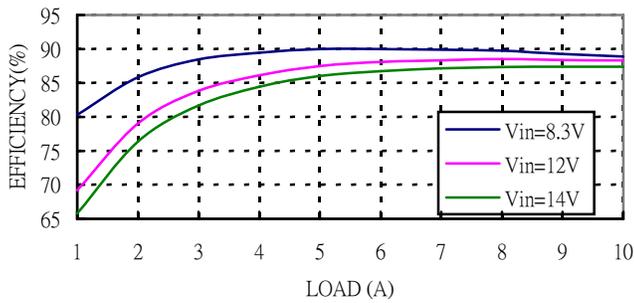


Figure 3: Converter efficiency vs. output current (1.5V output voltage)

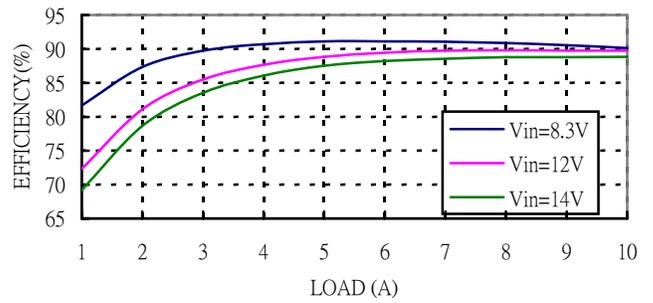


Figure 4: Converter efficiency vs. output current (1.8V output voltage)

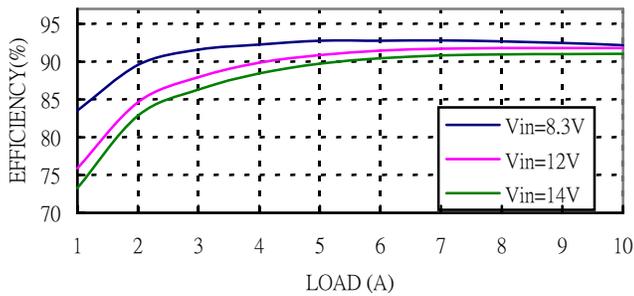


Figure 5: Converter efficiency vs. output current (2.5V output voltage)

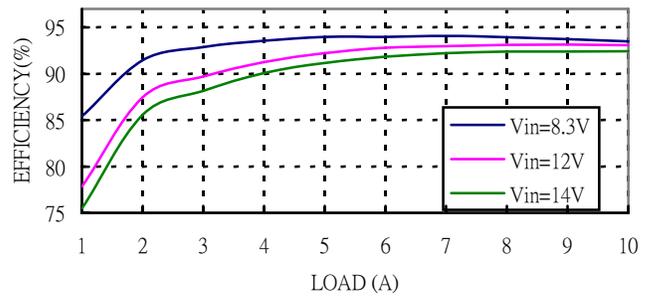


Figure 6: Converter efficiency vs. output current (3.3V output voltage)



ELECTRICAL CHARACTERISTICS CURVES

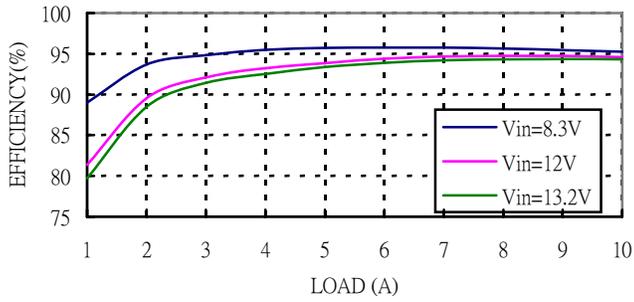


Figure 7: Converter efficiency vs. output current (5.0V output voltage)

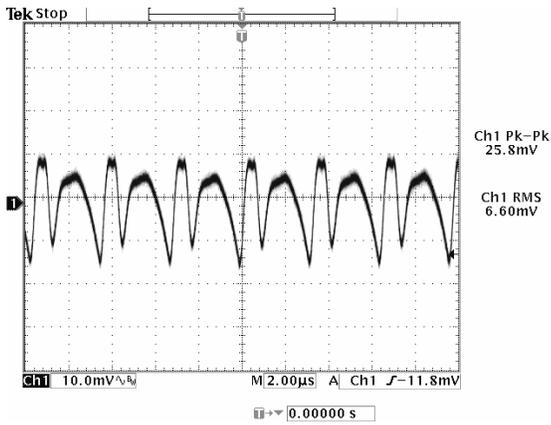


Figure 8: Output ripple & noise at 12Vin, 2.5V/10A out

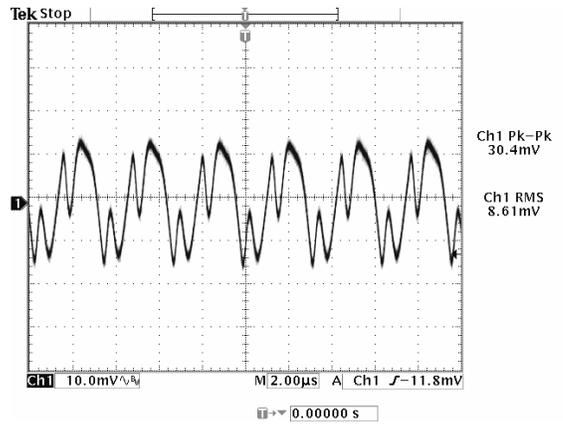


Figure 9: Output ripple & noise at 12Vin, 5.0V/10A out

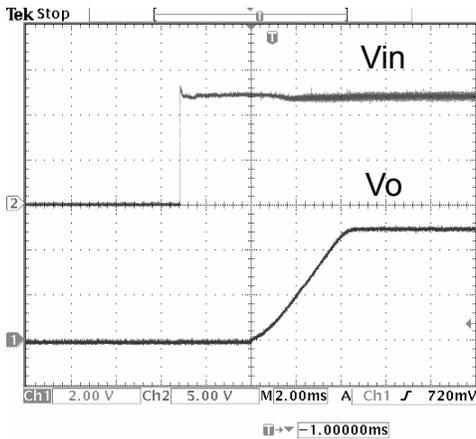


Figure 10: Turn on delay time at 12vin, 5.0V/10A out

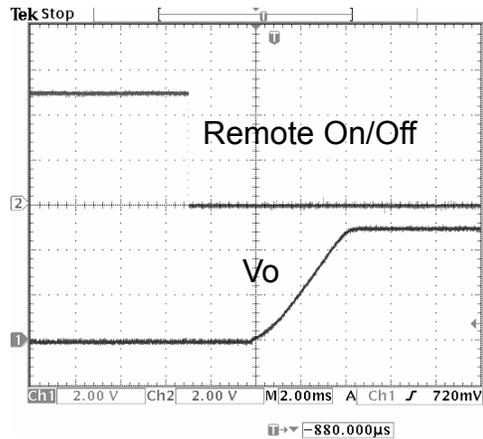


Figure 11: Turn on delay time at Remote On/Off, 5.0V/10A out



ELECTRICAL CHARACTERISTICS CURVES

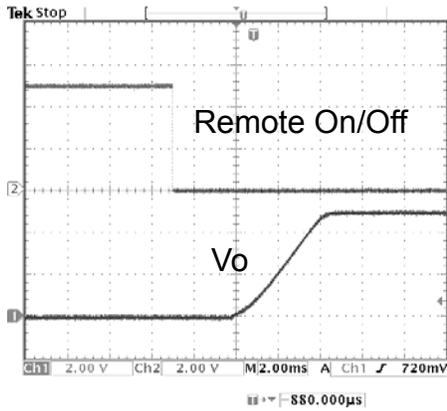


Figure 12: Turn on Using Remote On/Off with external capacitors ($C_o = 5000 \mu F$), 5.0V/10A out

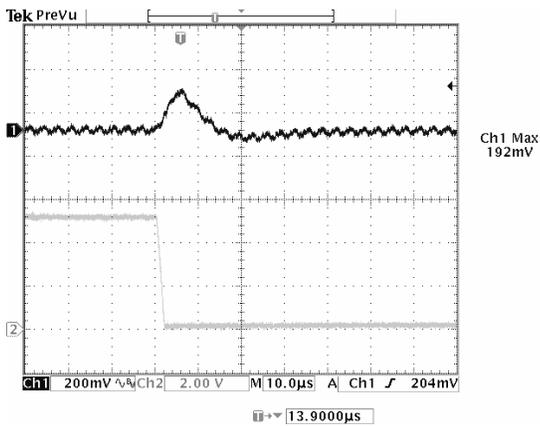


Figure 13: Typical transient response to step load change at $2.5A/\mu S$ from 100% to 50% of I_o , max at 12Vin, 5.0V out ($C_{out} = 1\mu F$ ceramic, $10\mu F$ tantalum)

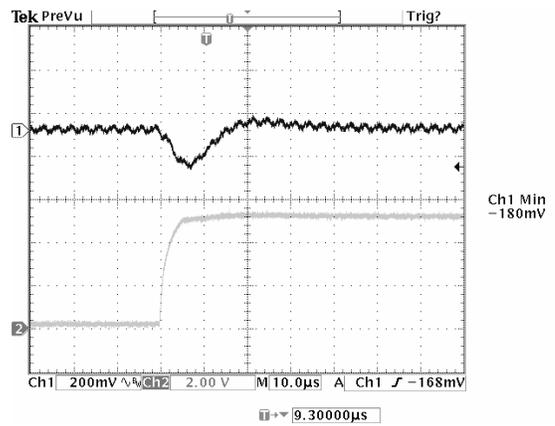


Figure 14: Typical transient response to step load change at $2.5A/\mu S$ from 50% to 100% of I_o , max at 12Vin, 5.0V out ($C_{out} = 1\mu F$ ceramic, $10\mu F$ tantalum)

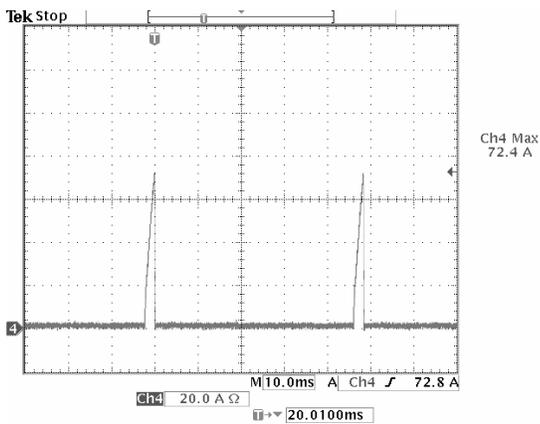


Figure 15: Output short circuit current 12Vin, 0.75Vout (10A/div)

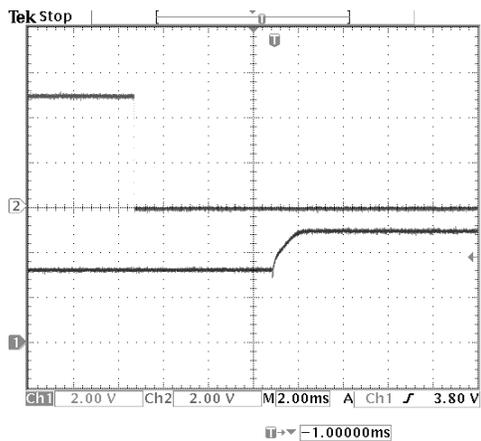
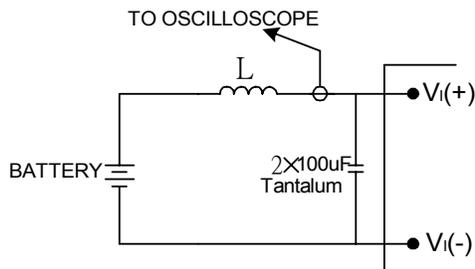


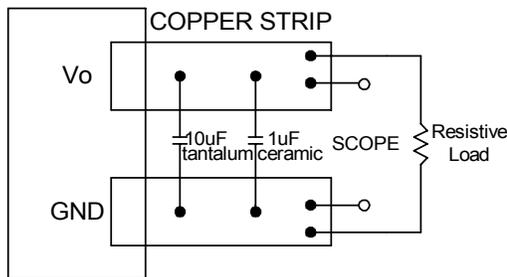
Figure 16: Turn on with Prebias 12Vin, 5V/0A out, $V_{bias} = 3.3Vdc$

TEST CONFIGURATIONS



Note: Input reflected-ripple current is measured with a simulated source inductance. Current is measured at the input of the module.

Figure 17: Input reflected-ripple test setup



Note: Use a 10µF tantalum and 1µF capacitor. Scope measurement should be made using a BNC connector.

Figure 18: Peak-peak output noise and startup transient measurement test setup

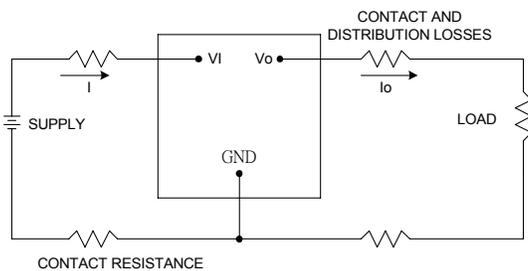


Figure 19: Output voltage and efficiency measurement test setup

Note: All measurements are taken at the module terminals. When the module is not soldered (via socket), place Kelvin connections at module terminals to avoid measurement errors due to contact resistance.

$$\eta = \left(\frac{V_o \times I_o}{V_i \times I_i} \right) \times 100 \%$$

DESIGN CONSIDERATIONS

Input Source Impedance

To maintain low-noise and ripple at the input voltage, it is critical to use low ESR capacitors at the input to the module. Figure 20 shows the input ripple voltage (mVp-p) for various output models using 4x47 uF low ESR tantalum capacitors (SANYO P/N:16TPB470M, 47uF/16V or equivalent) and 4x22 uF very low ESR ceramic capacitors (TDK P/N:C3225X7S1C226MT, 22uF/16V or equivalent).

The input capacitance should be able to handle an AC Ripple current of at least:

$$I_{rms} = I_{out} \sqrt{\frac{V_{out}}{V_{in}} \left(1 - \frac{V_{out}}{V_{in}} \right)} \quad A_{rms}$$

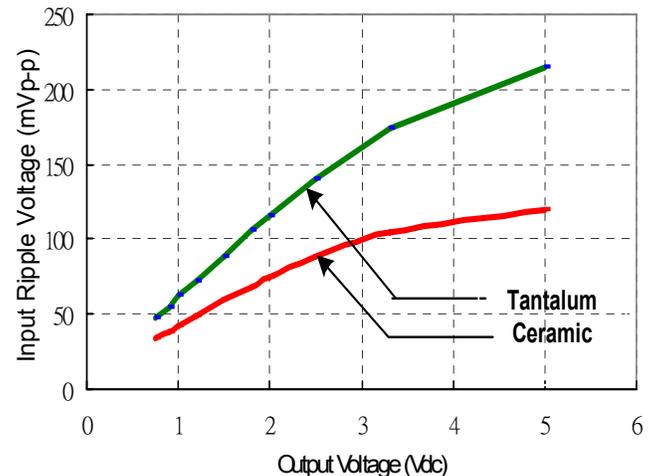


Figure 20: Input ripple voltage for various Output models, $I_o = 10A$ ($C_{in} = 4 \times 47\mu F$ tantalum capacitors and $4 \times 22\mu F$ ceramic capacitors at the input)

DESIGN CONSIDERATIONS (CON.)

The power module should be connected to a low ac-impedance input source. Highly inductive source impedances can affect the stability of the module. An input capacitance must be placed close to the modules input pins to filter ripple current and ensure module stability in the presence of inductive traces that supply the input voltage to the module.

Safety Considerations

For safety-agency approval the power module must be installed in compliance with the spacing and separation requirements of the end-use safety agency standards.

For the converter output to be considered meeting the requirements of safety extra-low voltage (SELV), the input must meet SELV requirements. The power module has extra-low voltage (ELV) outputs when all inputs are ELV.

The input to these units is to be provided with a maximum 15A of glass type fast-acting fuse in the ungrounded lead.

FEATURES DESCRIPTIONS

Remote On/Off

The DNM series power modules have an On/Off pin for remote On/Off operation. Both positive and negative On/Off logic options are available in the DNM series power modules.

For positive logic module, connect an open collector (NPN) transistor or open drain (N channel) MOSFET between the On/Off pin and the GND pin (see figure 21). Positive logic On/Off signal turns the module ON during the logic high and turns the module OFF during the logic low. When the positive On/Off function is not used, leave the pin floating or tie to V_{in} (module will be On).

For negative logic module, the On/Off pin is pulled high with an external pull-up resistor (see figure 22) Negative logic On/Off signal turns the module OFF during logic high and turns the module ON during logic low. If the negative On/Off function is not used, leave the pin floating or tie to GND. (module will be On)

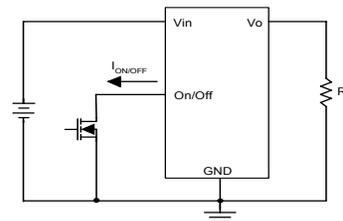


Figure 21: Positive remote On/Off implementation

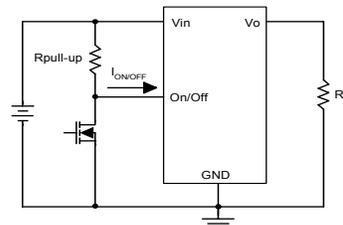


Figure 22: Negative remote On/Off implementation

Over-Current Protection

To provide protection in an output over load fault condition, the unit is equipped with internal over-current protection. When the over-current protection is triggered, the unit enters hiccup mode. The units operate normally once the fault condition is removed.

FEATURES DESCRIPTIONS (CON.)

Over-Temperature Protection

The over-temperature protection consists of circuitry that provides protection from thermal damage. If the temperature exceeds the over-temperature threshold the module will shut down. The module will try to restart after shutdown. If the over-temperature condition still exists during restart, the module will shut down again. This restart trial will continue until the temperature is within specification

Remote Sense

The DNM provide V_o remote sensing to achieve proper regulation at the load points and reduce effects of distribution losses on output line. In the event of an open remote sense line, the module shall maintain local sense regulation through an internal resistor. The module shall correct for a total of 0.1V of loss. The remote sense line impedance shall be $< 10\Omega$.

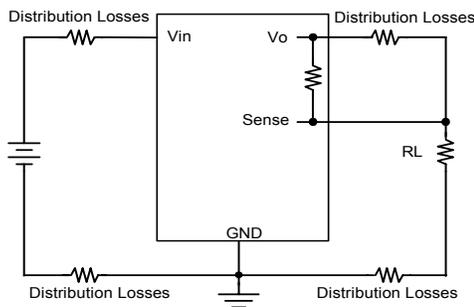


Figure 23: Effective circuit configuration for remote sense operation

Output Voltage Programming

The output voltage of the DNM can be programmed to any voltage between 0.75Vdc and 5.0Vdc by connecting one resistor (shown as R_{trim} in Figure 24) between the TRIM and GND pins of the module. Without this external resistor, the output voltage of the module is 0.7525 Vdc. To calculate the value of the resistor R_{trim} for a particular output voltage V_o , please use the following equation:

$$R_{trim} := \left(\frac{10500}{V_o - 0.7525} - 1000 \right) \cdot \Omega$$

R_{trim} is the external resistor in Ω
 V_o is the desired output voltage

For example, to program the output voltage of the DNM module to 3.3Vdc, R_{trim} is calculated as follows:

$$R_{trim} := \left(\frac{10500}{2.5475} - 1000 \right) \cdot \Omega$$

$$R_{trim} = 3.122 \text{ k}\Omega$$

DNM can also be programmed by applying a voltage between the TRIM and GND pins (Figure 25). The following equation can be used to determine the value of V_{trim} needed for a desired output voltage V_o :

$$V_{trim} := 0.7 - [(V_o - 0.7525) \cdot 0.0667]$$

V_{trim} is the external voltage in V
 V_o is the desired output voltage

For example, to program the output voltage of a DNM module to 3.3 Vdc, V_{trim} is calculated as follows

$$V_{trim} := 0.7 - (2.5475 \cdot 0.0667)$$

$$V_{trim} = 0.530V$$

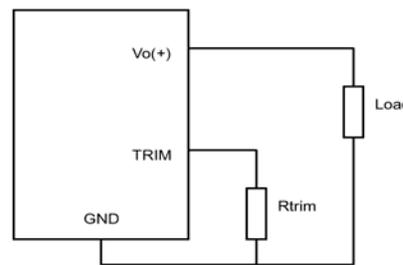


Figure 24: Circuit configuration for programming output voltage using an external resistor

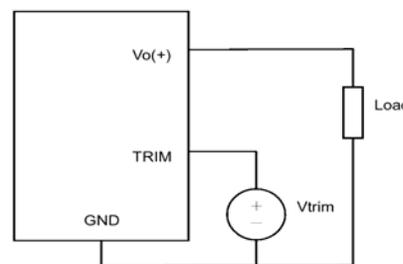


Figure 25: Circuit Configuration for programming output voltage using external voltage source

FEATURE DESCRIPTIONS (CON.)

Table 1 provides Rtrim values required for some common output voltages, while Table 2 provides value of external voltage source, Vtrim, for the same common output voltages. By using a 1% tolerance trim resistor, set point tolerance of $\pm 2\%$ can be achieved as specified in the electrical specification.

Table 1

VO (V)	Rtrim (K Ω)
0.7525	Open
1.2	22.464
1.5	13.047
1.8	9.024
2.5	5.009
3.3	3.122
5.0	1.472

Table 2

VO (V)	Vtrim (V)
0.7525	Open
1.2	0.670
1.5	0.650
1.8	0.630
2.5	0.583
3.3	0.530
5.0	0.4167

The amount of power delivered by the module is the voltage at the output terminals multiplied by the output current. When using the trim feature, the output voltage of the module can be increased, which at the same output current would increase the power output of the module. Care should be taken to ensure that the maximum output power of the module must not exceed the maximum rated power ($V_{o.set} \times I_{o.max} \leq P_{max}$).

Voltage Margining

Output voltage margining can be implemented in the DNM modules by connecting a resistor, $R_{margin-up}$, from the Trim pin to the ground pin for margining-up the output voltage and by connecting a resistor, $R_{margin-down}$, from the Trim pin to the output pin for margining-down. Figure 26 shows the circuit configuration for output voltage margining. If unused, leave the trim pin unconnected. A calculation tool is available from the evaluation procedure which computes the values of $R_{margin-up}$ and $R_{margin-down}$ for a specific output voltage and margin percentage.

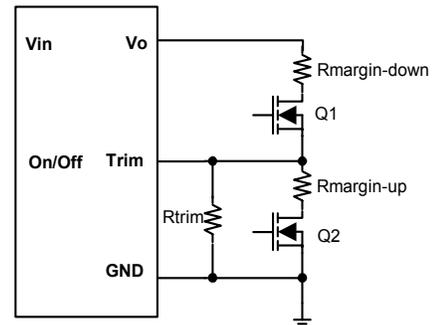


Figure 26: Circuit configuration for output voltage margining

Voltage Tracking

The DNM family was designed for applications that have output voltage tracking requirements during power-up and power-down. The devices have a TRACK pin to implement three types of tracking method: sequential, simultaneous and ratio-metric. TRACK simplifies the task of supply voltage tracking in a power system by enabling modules to track each other, or any external voltage, during power-up and power-down.

By connecting multiple modules together, customers can get multiple modules to track their output voltages to the voltage applied on the TRACK pin.



FEATURE DESCRIPTIONS (CON.)

The output voltage tracking feature (Figure 27 to Figure 29) is achieved according to the different external connections. If the tracking feature is not used, the TRACK pin of the module can be left unconnected or tied to V_{in} .

For proper voltage tracking, input voltage of the tracking power module must be applied in advance, and the remote on/off pin has to be in turn-on status. (Negative logic: Tied to GND or unconnected. Positive logic: Tied to V_{in} or unconnected)

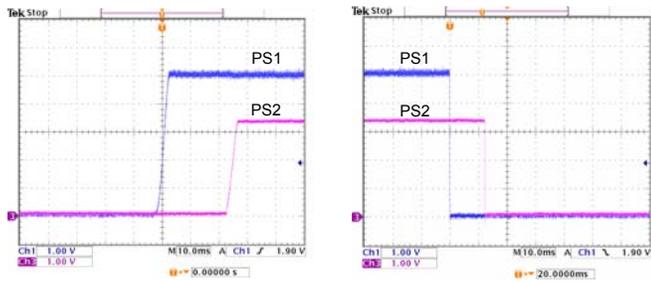


Figure 27: Sequential start-up

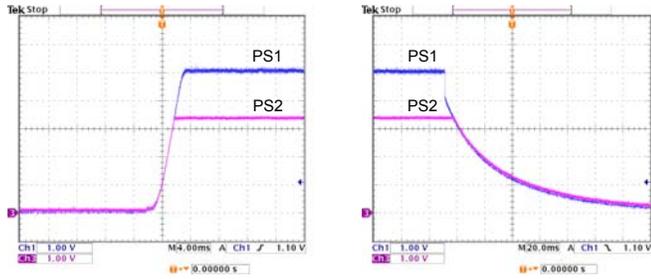


Figure 28: Simultaneous

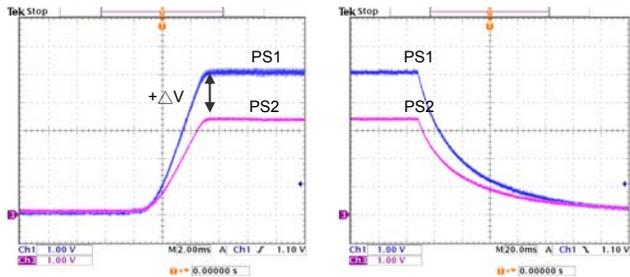
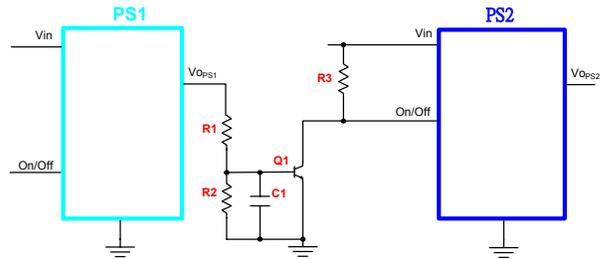


Figure 29: Ratio-metric

Sequential Start-up

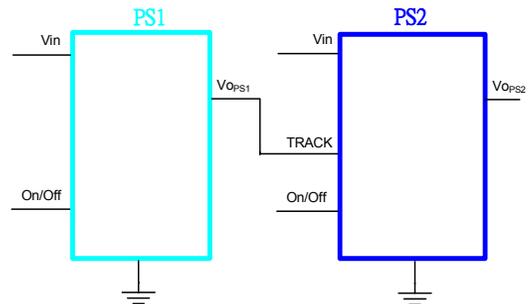
Sequential start-up (Figure 27) is implemented by placing an On/Off control circuit between V_{OP1} and the On/Off pin of PS2.



Simultaneous

Simultaneous tracking (Figure 28) is implemented by using the TRACK pin. The objective is to minimize the voltage difference between the power supply outputs during power up and down.

The simultaneous tracking can be accomplished by connecting V_{OP1} to the TRACK pin of PS2. Please note the voltage apply to TRACK pin needs to always higher than the V_{OP2} set point voltage.



FEATURE DESCRIPTIONS (CON.)

Ratio-Metric

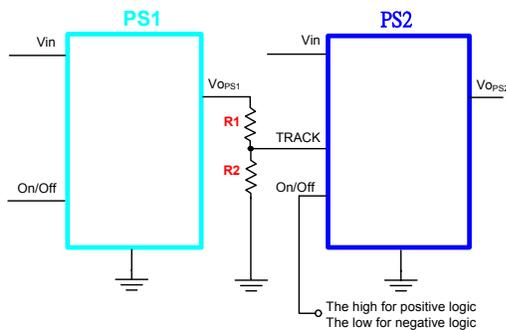
Ratio-metric (Figure 29) is implemented by placing the voltage divider on the TRACK pin that comprises R1 and R2, to create a proportional voltage with $V_{O,PS1}$ to the Track pin of PS2.

For Ratio-Metric applications that need the outputs of PS1 and PS2 reach the regulation set point at the same time

The following equation can be used to calculate the value of R1 and R2.

The suggested value of R2 is 10kΩ.

$$\frac{V_{o,PS2}}{V_{o,PS1}} = \frac{R_2}{R_1 + R_2}$$



THERMAL CONSIDERATIONS

Thermal management is an important part of the system design. To ensure proper, reliable operation, sufficient cooling of the power module is needed over the entire temperature range of the module. Convection cooling is usually the dominant mode of heat transfer.

Hence, the choice of equipment to characterize the thermal performance of the power module is a wind tunnel.

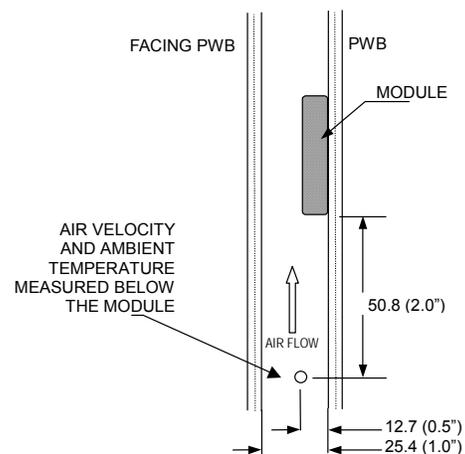
Thermal Testing Setup

Delta's DC/DC power modules are characterized in heated vertical wind tunnels that simulate the thermal environments encountered in most electronics equipment. This type of equipment commonly uses vertically mounted circuit cards in cabinet racks in which the power modules are mounted.

The following figure shows the wind tunnel characterization setup. The power module is mounted on a test PWB and is vertically positioned within the wind tunnel. The height of this fan duct is constantly kept at 25.4mm (1").

Thermal Derating

Heat can be removed by increasing airflow over the module. To enhance system reliability, the power module should always be operated below the maximum operating temperature. If the temperature exceeds the maximum module temperature, reliability of the unit may be affected.



Note: Wind Tunnel Test Setup Figure Dimensions are in millimeters and (Inches)

Figure 30: Wind tunnel test setup

THERMAL CURVES

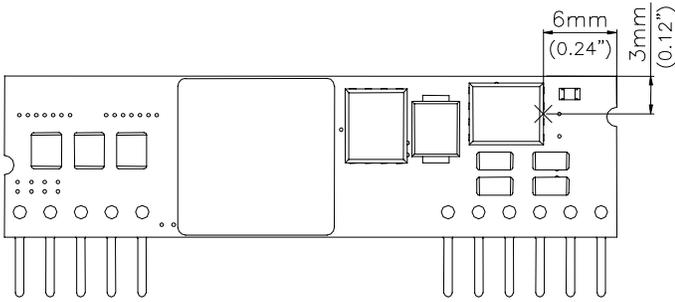


Figure 31: Temperature measurement location
The allowed maximum hot spot temperature is defined at 120°C

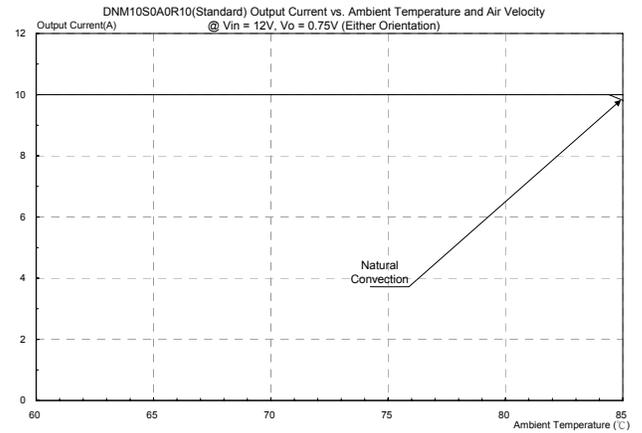


Figure 34: DNM10S0A0R10(Standard) Output current vs. ambient temperature and air velocity @ Vin=12V, Vo=0.75V(Either Orientation)

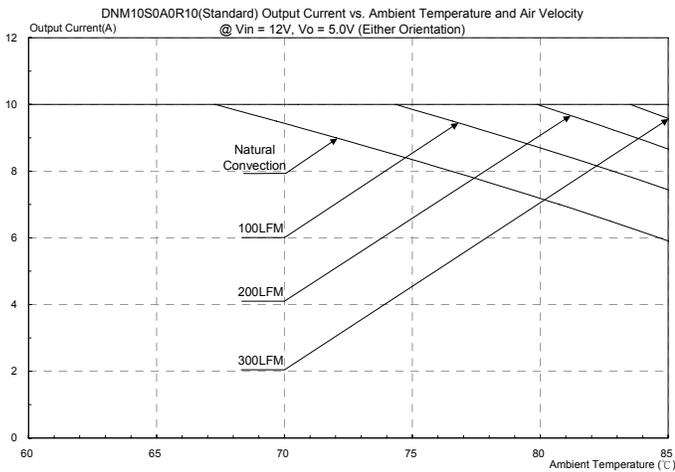


Figure 32: DNM10S0A0R10(Standard) Output current vs. ambient temperature and air velocity @ Vin=12V, Vo=5.0V(Either Orientation)

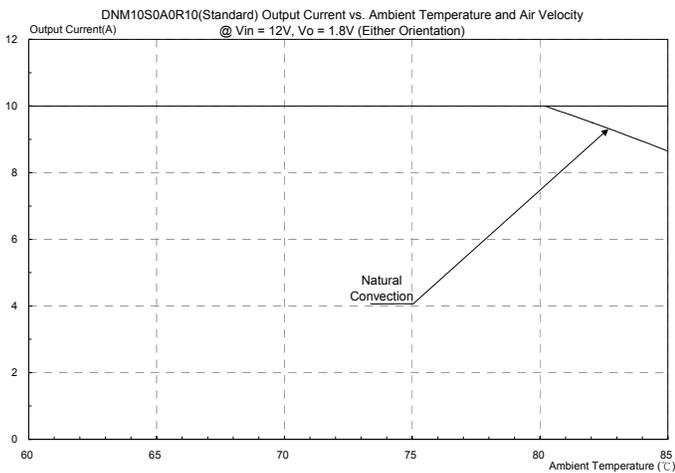
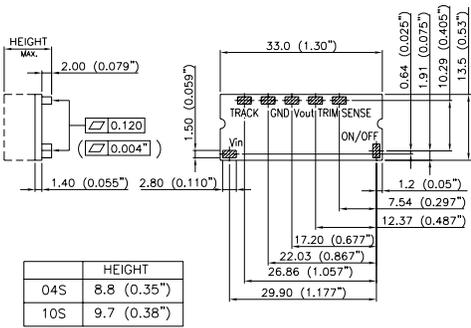


Figure 33: DNM10S0A0R10(Standard) Output current vs. ambient temperature and air velocity @ Vin=12V, Vo=1.8V(Either Orientation)
DS_DNM10SIP10_03062009

MECHANICAL DRAWING

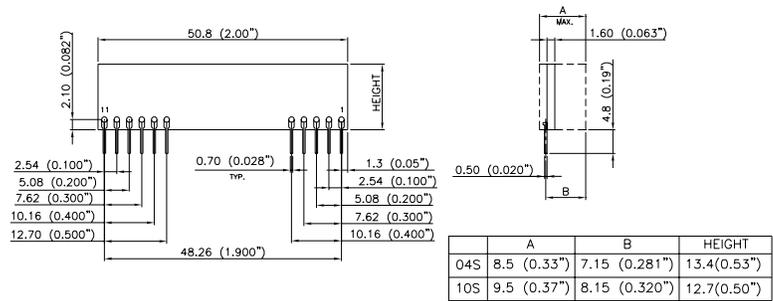
SMD PACKAGE (OPTIONAL)



SIDE VIEW

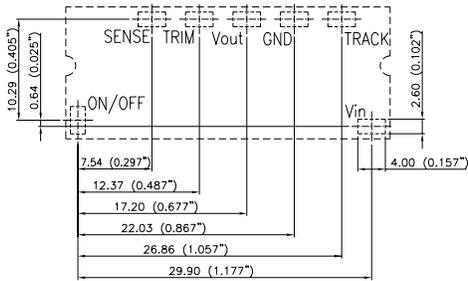
BOTTOM VIEW

SIP PACKAGE

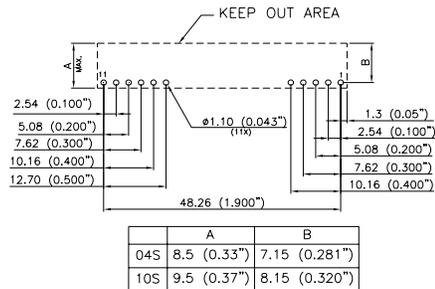


BACK VIEW

SIDE VIEW



RECOMMENDED P.W.B PAD LAYOUT



RECOMMENDED P.W.B PAD LAYOUT

PIN#	Function
1	Vo
2	Vo
3	Vo SENSE
4	Vo
5	GND
6	GND
7	Vi
8	Vi
9	TRACK
10	TRIM
11	ON/OFF

NOTES:
DIMENSIONS ARE IN MILLIMETERS AND (INCHES)
TOLERANCES: X.Xmm±0.5mm(X.XX in.±0.02 in.)
X.XXmm±0.25mm(X.XXX in.±0.010 in.)

PART NUMBERING SYSTEM

DNM	10	S	0A0	R	10	N	F	D
Product Series	Input Voltage	Numbers of Outputs	Output Voltage	Package Type	Output Current	On/Off logic		Option Code
DNL ~ 16A DNM ~ 10A DNS ~ 6A	04 - 2.8~5.5V 10 - 8.3~14V	S - Single	0A0 - Programmable	R - SIP S - SMD	10 - 10A	N- Negative (Default) P- Positive	F- RoHS 6/6 (Lead Free)	D- Standard Function

MODEL LIST

Model Name	Packaging	Input Voltage	Output Voltage	Output Current	On/Off logic	Efficiency 12Vin @ 100% load
DNM10S0A0S10PFD	SMD	8.3V ~ 14V	0.75V ~ 5.0V	10A	Positive	93.0% (3.3V)
DNM10S0A0S10NFD	SMD	8.3V ~ 14V	0.75V ~ 5.0V	10A	Negative	93.0% (3.3V)
DNM10S0A0R10PFD	SIP	8.3V ~ 14V	0.75V ~ 5.0V	10A	Positive	93.0% (3.3V)
DNM10S0A0R10NFD	SIP	8.3V ~ 14V	0.75V ~ 5.0V	10A	Negative	93.0% (3.3V)

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